

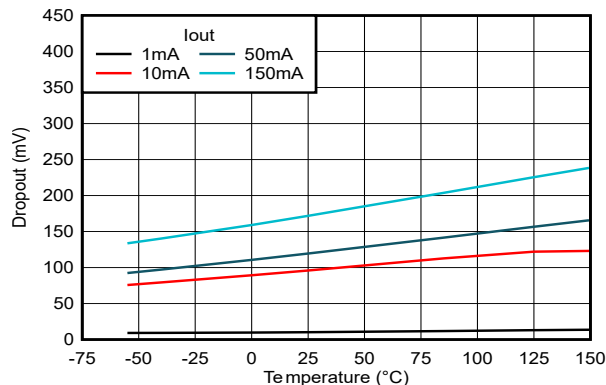
# LP2985-N 150mA, Low-Noise, Low-Power, Ultra-Low-Dropout Regulator in a SOT-23 Package

## 1 Features

- $V_{IN}$  range: 2.5V to 16V
- $V_{OUT}$  range (new chip):
  - 1.2V to 5.0V (fixed, 100mV steps)
- $V_{OUT}$  range (legacy chip): 2.5V to 6.1V
- $V_{OUT}$  accuracy:
  - $\pm 1\%$  for A-grade (legacy chip)
  - $\pm 1.5\%$  for standard-grade (legacy chip)
  - $\pm 0.5\%$  (new chip)
- Output accuracy over load, and temperature:
  - $\pm 1\%$  (new chip)
- Output current: Up to 150mA
- Low  $I_Q$  (new chip):  $71\mu A$  at  $I_{LOAD} = 0mA$
- Low  $I_Q$  (new chip):  $750\mu A$  at  $I_{LOAD} = 150mA$
- Shutdown current:
  - $0.05\mu A$  (typical, legacy chip)
  - $1.12\mu A$  (typical, new chip)
- Low noise:  $30\mu V_{RMS}$  with 10nF bypass capacitor
- Output current limiting and thermal protection
- Stable with 2.2 $\mu F$  ceramic capacitors (new chip)
- High PSRR: 70dB at 1kHz, 40dB at 1MHz
- Operating junction temperature:  $-40^{\circ}C$  to  $+125^{\circ}C$
- Package: 5-pin SOT-23 (DBV)

## 2 Applications

- Washers and dryers
- Land mobile radios
- Active antenna system mMIMO
- Cordless power tools
- Motor drives and control boards



Dropout Voltage vs Temperature (New Chip)

## 3 Description

The LP2985-N is a fixed-output, wide-input, low-noise, low-dropout voltage regulator. The device supports an input voltage range from 2.5V to 16V (new chip) and up to 150mA of load current. The LP2985-N supports an output range of 1.2V to 5.0V (new chip) and 2.5V to 6.1V (legacy chip).

Additionally, the LP2985-N (new chip) has a  $\pm 1\%$  output accuracy across load and temperature that can meet the needs of low-voltage microcontrollers (MCUs) and processors.

Low output noise of  $30\mu V_{RMS}$  (with 10nF bypass capacitors) and wide bandwidth PSRR performance of greater than 70dB at 1kHz and 40dB at 1MHz (for new chip) help attenuate the switching frequency of an upstream DC/DC converter and minimize post regulator filtering.

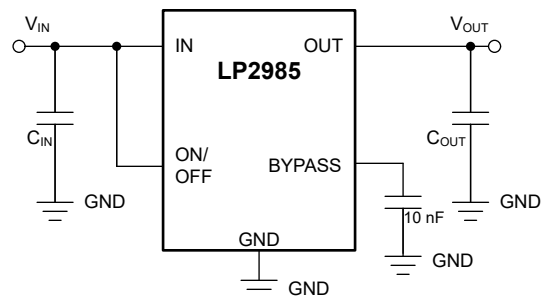
The new chip version of LP2985-N has internal soft-start mechanism that reduces inrush current during start up, thus minimizing input capacitance. Standard protection features, such as overcurrent and overtemperature protection, are included.

The LP2985-N is available in a 5-pin, 2.9mm  $\times$  2.8mm SOT-23 (DBV) package.

### Package Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> |
|-------------|------------------------|-----------------------------|
| LP2985-N    | DBV (SOT-23, 5)        | 2.9mm $\times$ 2.8mm        |

- (1) For more information, see the [Mechanical, Packaging, and Orderable Information](#).
- (2) The package size (length  $\times$  width) is a nominal value and includes pins, where applicable.



Typical Application Circuit



## Table of Contents

|                                                |           |                                                                  |           |
|------------------------------------------------|-----------|------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                        | <b>1</b>  | <b>7 Application and Implementation</b> .....                    | <b>18</b> |
| <b>2 Applications</b> .....                    | <b>1</b>  | 7.1 Application Information.....                                 | 18        |
| <b>3 Description</b> .....                     | <b>1</b>  | 7.2 Typical Application.....                                     | 23        |
| <b>4 Pin Configuration and Functions</b> ..... | <b>3</b>  | 7.3 Power Supply Recommendations.....                            | 28        |
| <b>5 Specifications</b> .....                  | <b>4</b>  | 7.4 Layout.....                                                  | 28        |
| 5.1 Absolute Maximum Ratings.....              | 4         | <b>8 Device and Documentation Support</b> .....                  | <b>29</b> |
| 5.2 ESD Ratings.....                           | 4         | 8.1 Documentation Support.....                                   | 29        |
| 5.3 Recommended Operating Conditions.....      | 4         | 8.2 Device Nomenclature.....                                     | 29        |
| 5.4 Thermal Information.....                   | 5         | 8.3 Receiving Notification of Documentation Updates....          | 29        |
| 5.5 Electrical Characteristics.....            | 5         | 8.4 Support Resources.....                                       | 29        |
| 5.6 Typical Characteristics.....               | 8         | 8.5 Trademarks.....                                              | 29        |
| <b>6 Detailed Description</b> .....            | <b>14</b> | 8.6 Electrostatic Discharge Caution.....                         | 29        |
| 6.1 Overview.....                              | 14        | 8.7 Glossary.....                                                | 29        |
| 6.2 Functional Block Diagrams.....             | 14        | <b>9 Revision History</b> .....                                  | <b>30</b> |
| 6.3 Feature Description.....                   | 15        | <b>10 Mechanical, Packaging, and Orderable Information</b> ..... | <b>30</b> |
| 6.4 Device Functional Modes.....               | 17        |                                                                  |           |

## 4 Pin Configuration and Functions



**Figure 4-1. DBV Package, 5-Pin SOT-23 (Top View)**

**Table 4-1. Pin Functions**

| PIN       |     | TYPE | DESCRIPTION                                                                                                                                                                                                                                       |
|-----------|-----|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME      | NO. |      |                                                                                                                                                                                                                                                   |
| BYPASS    | 4   | I/O  | BYPASS pin to achieve low noise performance. Connecting an external capacitor between the BYPASS pin and ground reduces reference voltage noise. See the <a href="#">Recommended Operating Conditions</a> section for more information.           |
| GND       | 2   | —    | Ground                                                                                                                                                                                                                                            |
| ON/OFF    | 3   | I    | Enable pin for the LDO. Driving the ON/OFF pin high enables the device. Driving this pin low disables the device. High and low thresholds are listed in the <a href="#">Electrical Characteristics</a> table. Tie this pin to $V_{IN}$ if unused. |
| $V_{IN}$  | 1   | I    | Input supply pin. Use a capacitor with a value of 1 $\mu$ F or larger from this pin to ground. See the <a href="#">Input Capacitor Requirements</a> section for more information.                                                                 |
| $V_{OUT}$ | 5   | O    | Output of the regulator. Use a capacitor with a value of 2.2 $\mu$ F or larger from this pin to ground. <sup>(1)</sup> See the <a href="#">Output Capacitor Requirements</a> section for more information.                                        |

- (1) The nominal output capacitance must be greater than 2.2  $\mu$ F. Throughout this document, the nominal derating on these capacitors is 50%. Make sure that the effective capacitance at the pin is greater than 1  $\mu$ F.

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1) (2)</sup>

|                    |                                                       | MIN                | MAX                                        | UNIT |
|--------------------|-------------------------------------------------------|--------------------|--------------------------------------------|------|
| $V_{IN}$           | Continuous input voltage range (for legacy chip)      | −0.3               | 16                                         | V    |
|                    | Continuous input voltage range (for new chip)         | −0.3               | 18                                         |      |
| $V_{OUT}$          | Output voltage range (for legacy chip)                | −0.3               | 9                                          | V    |
|                    | Output voltage range (for new chip)                   | −0.3               | $V_{IN} + 0.3$ or 9 (whichever is smaller) |      |
| $V_{BYPASS}$       | BYPASS pin voltage range (for new chip)               | −0.3               | 3                                          | V    |
| $V_{ON/OFF}$       | ON/OFF pin voltage range (for legacy chip)            | −0.3               | 16                                         | V    |
|                    | ON/OFF pin voltage range (for new chip)               | −0.3               | 18                                         |      |
| $V_{IN} - V_{OUT}$ | Input – Output differential voltage (for legacy chip) | −0.3               | 16                                         | V    |
|                    | Input – Output differential voltage (for new chip)    | −0.3               | 18                                         |      |
| Current            | Maximum output                                        | Internally limited |                                            | A    |
| Temperature        | Operating junction, $T_J$                             | −55                | 150                                        | °C   |
|                    | Storage, $T_{stg}$                                    | −65                | 150                                        |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages with respect to GND.

### 5.2 ESD Ratings

|             |                         |                                                                                | VALUE<br>(Legacy<br>Chip) | VALUE<br>(New<br>Chip) | UNIT |
|-------------|-------------------------|--------------------------------------------------------------------------------|---------------------------|------------------------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000                     | ±3000                  | V    |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500                      | ±1000                  |      |

- (1) JEDEC document JEP155 states that 2-kV HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 500-V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

|               |                                        | MIN | NOM | MAX      | UNIT |
|---------------|----------------------------------------|-----|-----|----------|------|
| $V_{IN}$      | Supply input voltage (for legacy chip) | 3.1 |     | 16       | V    |
|               | Supply input voltage (for new chip)    | 2.5 |     | 16       |      |
| $V_{OUT}$     | Output voltage (for legacy chip)       | 1.2 |     | 10.0     |      |
|               | Output voltage (for new chip)          | 1.2 |     | 5.0      |      |
| $V_{BYPASS}$  | Bypass voltage                         |     | 1.2 |          |      |
| $V_{ON/OFF}$  | Enable voltage (for legacy chip)       | 0   |     | $V_{IN}$ |      |
|               | Enable voltage (for new chip)          | 0   |     | 16       |      |
| $I_{OUT}$     | Output current                         | 0   |     | 150      | mA   |
| $C_{IN}$      | Input capacitor                        |     | 1   |          | μF   |
| $C_{OUT}$     | Output capacitance (for legacy chip)   | 2.2 | 4.7 |          | μF   |
|               | Output capacitance (for new chip)      | 1   | 2.2 | 200      |      |
| $C_{OUT}$ ESR | Output capacitor ESR (for new chip)    | 0   |     | 1        | Ω    |
| $T_J$         | Operating junction temperature         | −40 |     | 125      | °C   |

## 5.4 Thermal Information

| THERMAL METRIC (2) (1) |                                              | Legacy Chip   | New Chip      | UNIT |
|------------------------|----------------------------------------------|---------------|---------------|------|
|                        |                                              | DBV (SOT23-5) | DBV (SOT23-5) |      |
|                        |                                              | 5 PINS        | 5 PINS        |      |
| $R_{\theta JA}$        | Junction-to-ambient thermal resistance       | 205.4         | 178.6         | °C/W |
| $R_{\theta JC(top)}$   | Junction-to-case (top) thermal resistance    | 78.8          | 77.9          | °C/W |
| $R_{\theta JB}$        | Junction-to-board thermal resistance         | 46.7          | 47.2          | °C/W |
| $\Psi_{JT}$            | Junction-to-top characterization parameter   | 8.3           | 15.9          | °C/W |
| $\Psi_{JB}$            | Junction-to-board characterization parameter | 46.3          | 46.9          | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.
- (2) Thermal performance results are based on the JEDEC standard of 2s2p PCB configuration. These thermal metric parameters can be further improved by 35-55% based on thermally optimized PCB layout designs. See the analysis of the [Impact of board layout on LDO thermal performance](#) application note.

## 5.5 Electrical Characteristics

specified at  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + 1.0\text{ V}$  or  $V_{IN} = 2.5\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{ON/OFF} = 2\text{ V}$ ,  $C_{IN} = 1.0\text{ }\mu\text{F}$ , and  $C_{OUT} = 2.2\text{ }\mu\text{F}$  (unless otherwise noted)

| PARAMETER                       |                          | TEST CONDITIONS                                                                                           |                              | MIN  | TYP   | MAX   | UNIT |
|---------------------------------|--------------------------|-----------------------------------------------------------------------------------------------------------|------------------------------|------|-------|-------|------|
| $\Delta V_{OUT}$                | Output voltage tolerance | $I_L = 1\text{ mA}$                                                                                       | Legacy chip (standard grade) | -1.5 |       | 1.5   | %    |
|                                 |                          |                                                                                                           | Legacy chip (A grade)        | -1.0 |       | 1.0   |      |
|                                 |                          |                                                                                                           | New chip                     | -0.5 |       | 0.5   |      |
|                                 |                          | $1\text{ mA} \leq I_L \leq 50\text{ mA}$                                                                  | Legacy chip (standard grade) | -2.5 |       | 2.5   |      |
|                                 |                          |                                                                                                           | Legacy chip (A grade)        | -1.5 |       | 1.5   |      |
|                                 |                          |                                                                                                           | New chip                     | -0.5 |       | 0.5   |      |
|                                 |                          | $1\text{ mA} \leq I_L \leq 150\text{ mA}$                                                                 | Legacy chip (standard grade) | -3.0 |       | 3.0   |      |
|                                 |                          |                                                                                                           | Legacy chip (A grade)        | -2.5 |       | 2.5   |      |
|                                 |                          |                                                                                                           | New chip                     | -0.5 |       | 0.5   |      |
|                                 |                          | $1\text{ mA} \leq I_L \leq 50\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$               | Legacy chip (standard grade) | -3.5 |       | 3.5   |      |
|                                 |                          |                                                                                                           | Legacy chip (A grade)        | -2.5 |       | 2.5   |      |
|                                 |                          |                                                                                                           | New chip                     | -1   |       | 1     |      |
|                                 |                          | $1\text{ mA} \leq I_L \leq 150\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$              | Legacy chip (standard grade) | -4.0 |       | 4.0   |      |
|                                 |                          |                                                                                                           | Legacy chip (A grade)        | -3.5 |       | 3.5   |      |
|                                 |                          |                                                                                                           | New chip                     | -1   |       | 1     |      |
| $\Delta V_{OUT(\Delta V_{IN})}$ | Line regulation          | $V_{O(NOM)} + 1\text{ V} \leq V_{IN} \leq 16\text{ V}$                                                    | Legacy chip                  |      | 0.007 | 0.014 | %V   |
|                                 |                          |                                                                                                           | New chip                     |      | 0.002 | 0.014 |      |
|                                 |                          | $V_{O(NOM)} + 1\text{ V} \leq V_{IN} \leq 16\text{ V}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$ | Legacy chip                  |      | 0.007 | 0.032 |      |
|                                 |                          |                                                                                                           | New chip                     |      | 0.002 | 0.032 |      |

## 5.5 Electrical Characteristics (continued)

specified at  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + 1.0\text{ V}$  or  $V_{IN} = 2.5\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{ON/OFF} = 2\text{ V}$ ,  $C_{IN} = 1.0\text{ }\mu\text{F}$ , and  $C_{OUT} = 2.2\text{ }\mu\text{F}$  (unless otherwise noted)

| PARAMETER          |                                | TEST CONDITIONS                                                                                      |             | MIN | TYP  | MAX  | UNIT          |
|--------------------|--------------------------------|------------------------------------------------------------------------------------------------------|-------------|-----|------|------|---------------|
| $V_{IN} - V_{OUT}$ | Dropout voltage <sup>(1)</sup> | $I_{OUT} = 0\text{ mA}$                                                                              | Legacy chip |     | 1    | 3    | mV            |
|                    |                                |                                                                                                      | New chip    |     | 1    | 2.75 |               |
|                    |                                | $I_{OUT} = 0\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip |     |      | 5    |               |
|                    |                                |                                                                                                      | New chip    |     |      | 3    |               |
|                    |                                | $I_{OUT} = 1\text{ mA}$                                                                              | Legacy chip |     | 7    | 10   |               |
|                    |                                |                                                                                                      | New chip    |     | 11.5 | 14   |               |
|                    |                                | $I_{OUT} = 1\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip |     |      | 15   |               |
|                    |                                |                                                                                                      | New chip    |     |      | 17   |               |
|                    |                                | $I_{OUT} = 10\text{ mA}$                                                                             | Legacy chip |     | 40   | 60   |               |
|                    |                                |                                                                                                      | New chip    |     | 98   | 115  |               |
|                    |                                | $I_{OUT} = 10\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                          | Legacy chip |     |      | 90   |               |
|                    |                                |                                                                                                      | New chip    |     |      | 148  |               |
|                    |                                | $I_{OUT} = 50\text{ mA}$                                                                             | Legacy chip |     | 120  | 150  |               |
|                    |                                |                                                                                                      | New chip    |     | 120  | 145  |               |
|                    |                                | $I_{OUT} = 50\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                          | Legacy chip |     |      | 225  |               |
|                    |                                |                                                                                                      | New chip    |     |      | 184  |               |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 0\text{ mA}$                                                                              | Legacy chip |     | 65   | 95   | $\mu\text{A}$ |
|                    |                                |                                                                                                      | New chip    |     | 69   | 95   |               |
|                    |                                | $I_{OUT} = 0\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip |     |      | 125  |               |
|                    |                                |                                                                                                      | New chip    |     |      | 123  |               |
|                    |                                | $I_{OUT} = 1\text{ mA}$                                                                              | Legacy chip |     | 75   | 110  |               |
|                    |                                |                                                                                                      | New chip    |     | 78   | 110  |               |
|                    |                                | $I_{OUT} = 1\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip |     |      | 170  |               |
|                    |                                |                                                                                                      | New chip    |     |      | 140  |               |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 10\text{ mA}$                                                                             | Legacy chip |     | 120  | 220  | $\mu\text{A}$ |
|                    |                                |                                                                                                      | New chip    |     | 175  | 210  |               |
|                    |                                | $I_{OUT} = 10\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                          | Legacy chip |     |      | 400  |               |
|                    |                                |                                                                                                      | New chip    |     |      | 250  |               |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 50\text{ mA}$                                                                             | Legacy chip |     | 350  | 600  | $\mu\text{A}$ |
|                    |                                |                                                                                                      | New chip    |     | 380  | 440  |               |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 50\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                          | Legacy chip |     |      | 900  | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 50\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                          | New chip    |     |      | 650  | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 150\text{ mA}$                                                                            | Legacy chip |     | 850  | 1200 | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 150\text{ mA}$                                                                            | New chip    |     | 765  | 890  | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 150\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                         | Legacy chip |     |      | 2000 | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $I_{OUT} = 150\text{ mA}, -40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                         | New chip    |     |      | 1060 | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $V_{ON/OFF} < 0.3\text{ V}, V_{IN} = 16\text{ V}$                                                    | Legacy chip |     | 0.01 | 0.08 | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $V_{ON/OFF} < 0.3\text{ V}, V_{IN} = 16\text{ V}$                                                    | New chip    |     | 1.25 | 1.75 | $\mu\text{A}$ |
| $I_{GND}$          | GND pin current                | $V_{ON/OFF} < 0.15\text{ V}, V_{IN} = 16\text{ V}, -40^\circ\text{C} \leq T_J \leq 85^\circ\text{C}$ | Legacy chip |     | 0    | 1    | $\mu\text{A}$ |

## 5.5 Electrical Characteristics (continued)

specified at  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + 1.0\text{ V}$  or  $V_{IN} = 2.5\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{ON/OFF} = 2\text{ V}$ ,  $C_{IN} = 1.0\text{ }\mu\text{F}$ , and  $C_{OUT} = 2.2\text{ }\mu\text{F}$  (unless otherwise noted)

| PARAMETER                  |                            | TEST CONDITIONS                                                                                                                                        |             | MIN   | TYP  | MAX | UNIT             |
|----------------------------|----------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-------|------|-----|------------------|
| $I_{GND}$                  | GND pin current            | $V_{ON/OFF} < 0.15\text{ V}$ , $V_{IN} = 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 85^\circ\text{C}$                                             | New chip    | 1.12  | 2.25 |     | $\mu\text{A}$    |
| $I_{GND}$                  | GND pin current            | $V_{ON/OFF} < 0.15\text{ V}$ , $V_{IN} = 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                            | Legacy chip | 0.01  | 2    |     | $\mu\text{A}$    |
| $I_{GND}$                  | GND pin current            | $V_{ON/OFF} < 0.15\text{ V}$ , $V_{IN} = 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                            | New chip    | 1.12  | 2.75 |     | $\mu\text{A}$    |
| $V_{UVLO+}$                | Rising bias supply UVLO    | $V_{IN}$ rising, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                                                                   | New chip    | 2.2   | 2.4  |     | V                |
| $V_{UVLO-}$                | Falling bias supply UVLO   | $V_{IN}$ falling, $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                                                                  |             | 1.9   |      |     | V                |
| $V_{UVLO(HYST)}$           | UVLO hysteresis            | $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                                                                                    |             | 0.130 |      |     | V                |
| $V_{ON/OFF}$               | ON/OFF input voltage       | Low = Output OFF                                                                                                                                       | Legacy chip | 0.55  |      |     | V                |
|                            |                            |                                                                                                                                                        | New chip    | 0.72  |      |     |                  |
|                            |                            | Low = Output OFF, $V_{OUT} + 1 \leq V_{IN} \leq 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                     | Legacy chip |       | 0.15 |     |                  |
|                            |                            |                                                                                                                                                        | New chip    |       | 0.15 |     |                  |
|                            |                            | High = Output ON                                                                                                                                       | Legacy chip | 1.4   |      |     |                  |
|                            |                            |                                                                                                                                                        | New chip    | 0.85  |      |     |                  |
|                            |                            | High = Output ON, $V_{OUT} + 1 \leq V_{IN} \leq 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                                     | Legacy chip | 1.6   |      |     |                  |
|                            |                            |                                                                                                                                                        | New chip    | 1.6   |      |     |                  |
| $I_{ON/OFF}$               | ON/OFF input current       | $V_{ON/OFF} = 0\text{ V}$                                                                                                                              | Legacy chip | 0.01  |      |     | $\mu\text{A}$    |
|                            |                            |                                                                                                                                                        | New chip    | 0.42  |      |     |                  |
| $I_{ON/OFF}$               | ON/OFF input current       | $V_{ON/OFF} = 0\text{ V}$ , $V_{OUT} + 1 \leq V_{IN} \leq 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip |       | -1   |     | $\mu\text{A}$    |
|                            |                            |                                                                                                                                                        | New chip    |       | -0.9 |     | $\mu\text{A}$    |
|                            |                            | $V_{ON/OFF} = 5\text{ V}$                                                                                                                              | Legacy chip | 5     |      |     | $\mu\text{A}$    |
|                            |                            |                                                                                                                                                        | New chip    | 0.011 |      |     | $\mu\text{A}$    |
|                            |                            | $V_{ON/OFF} = 5\text{ V}$ , $V_{OUT} + 1 \leq V_{IN} \leq 16\text{ V}$ , $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                           | Legacy chip | 15    |      |     | $\mu\text{A}$    |
|                            |                            |                                                                                                                                                        | New chip    | 2.20  |      |     | $\mu\text{A}$    |
| $I_O(PK)$                  | Peak output current        | $V_{OUT} \geq V_{O(NOM)} - 5\%$ (steady state)                                                                                                         | Legacy chip | 300   | 350  |     | mA               |
|                            |                            |                                                                                                                                                        | New chip    | 300   | 350  |     |                  |
| $I_{O(SC)}$                | Short output current       | $R_L = 0\text{ }\Omega$ (steady state)                                                                                                                 | Legacy chip | 400   |      |     |                  |
|                            |                            |                                                                                                                                                        | New chip    | 375   |      |     |                  |
| $\Delta V_O/\Delta V_{IN}$ | Ripple rejection           | $f = 1\text{ kHz}$ , $C_{BYPASS} = 10\text{ nF}$ , $C_{OUT} = 10\text{ }\mu\text{F}$                                                                   | Legacy chip | 45    |      |     | dB               |
|                            |                            |                                                                                                                                                        | New chip    | 78    |      |     |                  |
| $V_n$                      | Output noise voltage       | Bandwidth = 300 Hz to 50 kHz, $C_{BYPASS} = 10\text{ nF}$ , $C_{OUT} = 2.2\text{ }\mu\text{F}$ , $V_{OUT} = 3.3\text{ V}$ , $I_{LOAD} = 150\text{ mA}$ | Legacy chip | 30    |      |     | $\mu\text{VRMS}$ |
|                            |                            | Bandwidth = 300 Hz to 50 kHz, $C_{BYPASS} = 10\text{ nF}$ , $C_{OUT} = 2.2\text{ }\mu\text{F}$ , $V_{OUT} = 3.3\text{ V}$ , $I_{LOAD} = 150\text{ mA}$ | New chip    | 30    |      |     |                  |
| $T_{sd+}$                  | Thermal shutdown threshold | Shutdown, temperature increasing                                                                                                                       | New chip    | 170   |      |     | $^\circ\text{C}$ |
| $T_{sd-}$                  |                            | Reset, temperature decreasing                                                                                                                          |             | 150   |      |     |                  |

- (1) Dropout voltage ( $V_{DO}$ ) is defined as the input-to-output differential at which the output voltage drops 100 mV below the value measured with a 1 V differential.  $V_{DO}$  is measured with  $V_{IN} = V_{OUT(nom)} - 100\text{ mV}$  for fixed output devices.

## 5.6 Typical Characteristics

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)

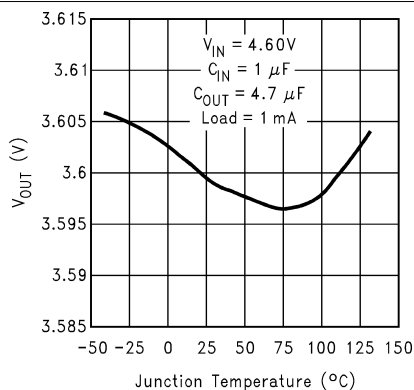


Figure 5-1.  $V_{OUT}$  vs Temperature (Legacy Chip)

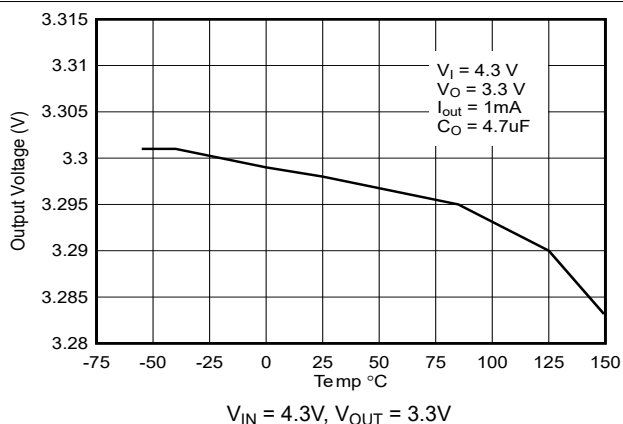


Figure 5-2.  $V_{OUT}$  vs Temperature (New Chip)

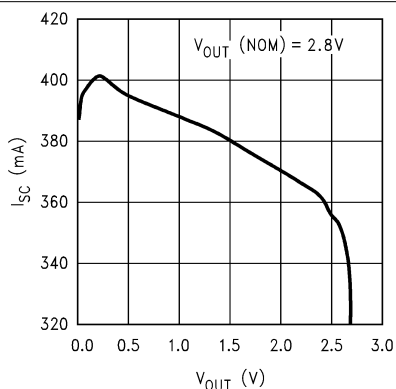


Figure 5-3. Short-Circuit Current vs Output Voltage (Legacy Chip)

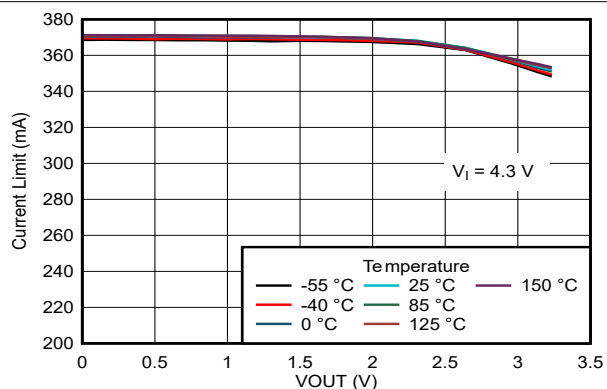


Figure 5-4. Short-Circuit Current vs Output Voltage (New Chip)

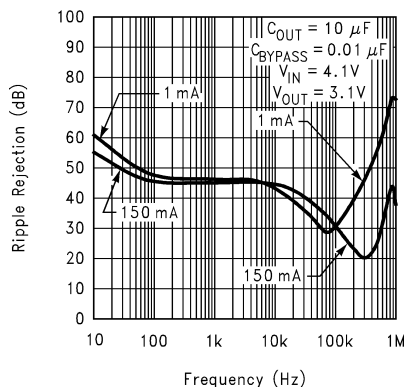


Figure 5-5. Ripple Rejection vs Frequency (Legacy Chip)

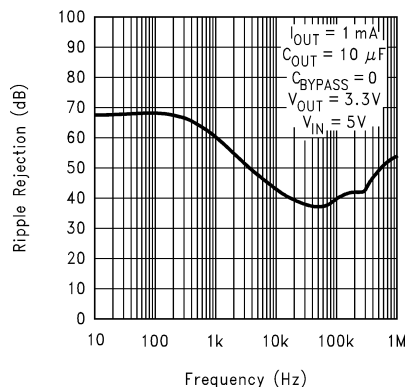


Figure 5-6. Ripple Rejection vs Frequency (Legacy Chip)

## 5.6 Typical Characteristics (continued)

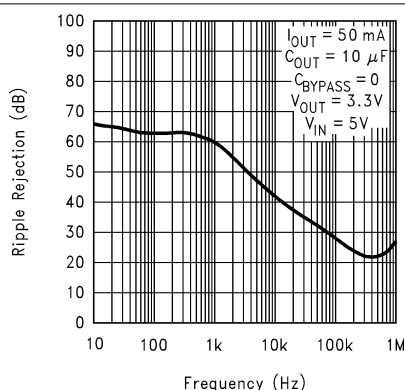


Figure 5-7. Ripple Rejection vs Frequency (Legacy Chip)

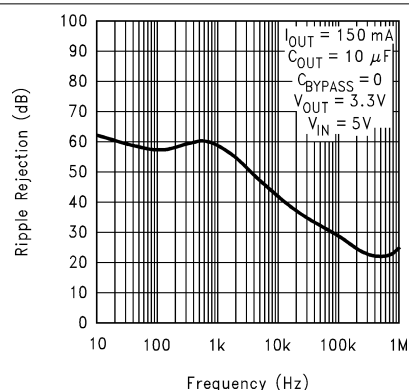


Figure 5-8. Ripple Rejection vs Frequency (Legacy Chip)

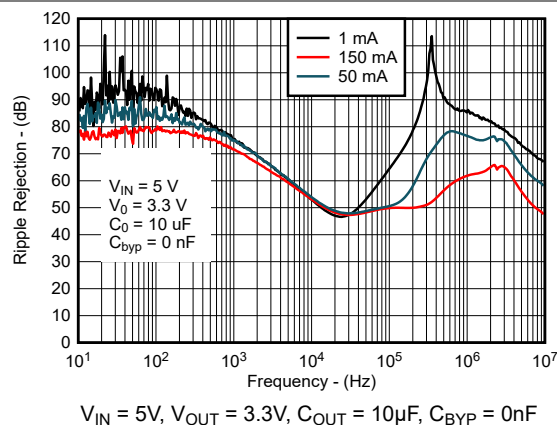


Figure 5-9. Ripple Rejection vs Frequency (New Chip)

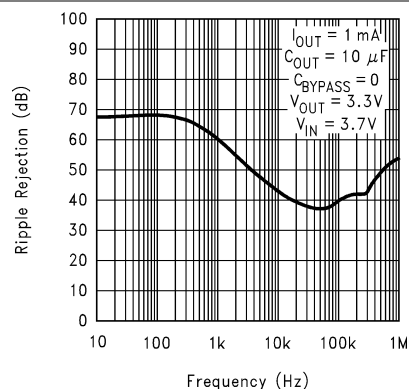


Figure 5-10. Ripple Rejection vs Frequency (Legacy Chip)

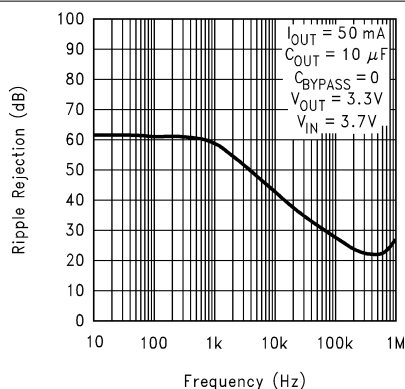


Figure 5-11. Ripple Rejection vs Frequency (Legacy Chip)

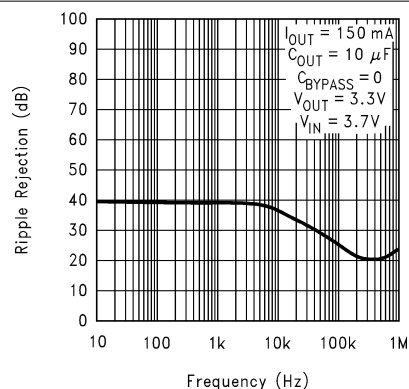


Figure 5-12. Ripple Rejection vs Frequency (Legacy Chip)

## 5.6 Typical Characteristics (continued)

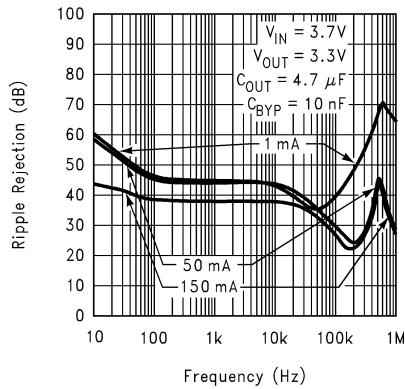


Figure 5-13. Ripple Rejection vs Frequency (Legacy Chip)

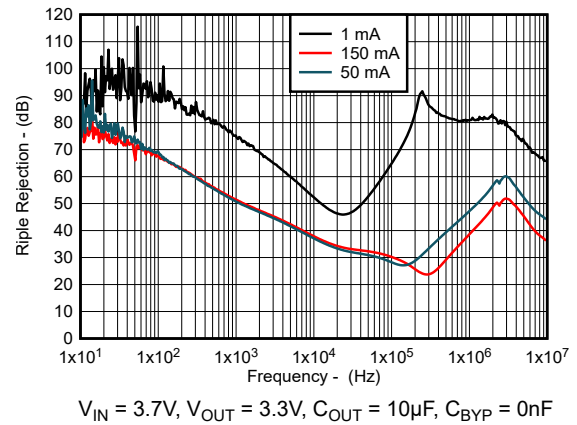


Figure 5-14. Ripple Rejection vs Frequency (New Chip)

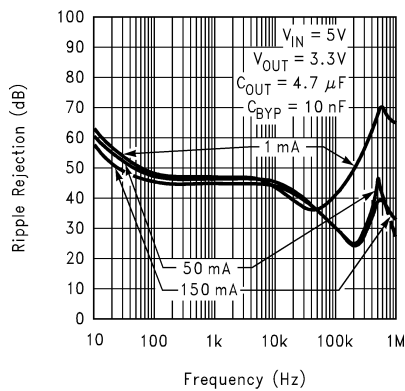


Figure 5-15. Ripple Rejection vs Frequency (Legacy Chip)

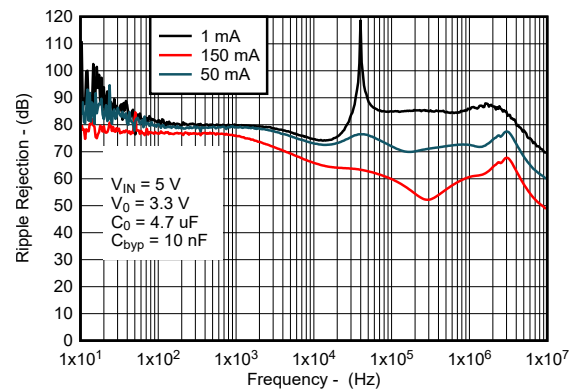


Figure 5-16. Ripple Rejection vs Frequency (New Chip)

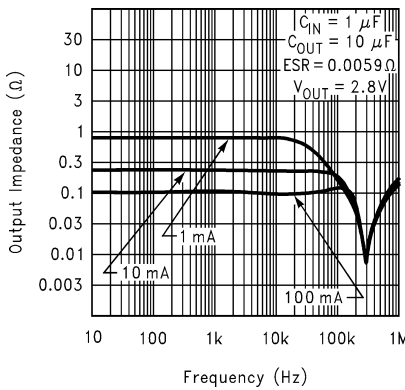


Figure 5-17. Output Impedance vs Frequency (Legacy Chip)

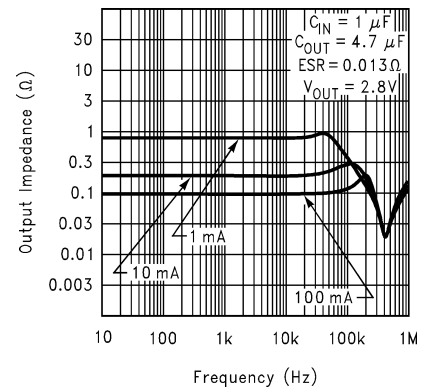


Figure 5-18. Output Impedance vs Frequency (Legacy Chip)

## 5.6 Typical Characteristics (continued)



Figure 5-19. Output Noise Density (Legacy Chip)



Figure 5-20. Output Noise Density vs Frequency (New Chip)

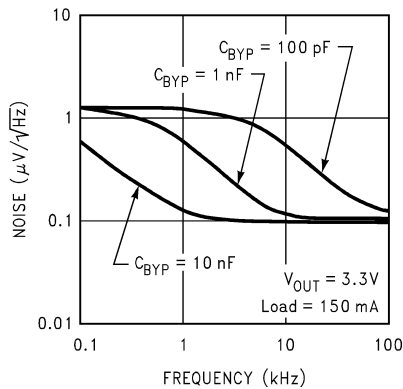


Figure 5-21. Output Noise Density (Legacy Chip)

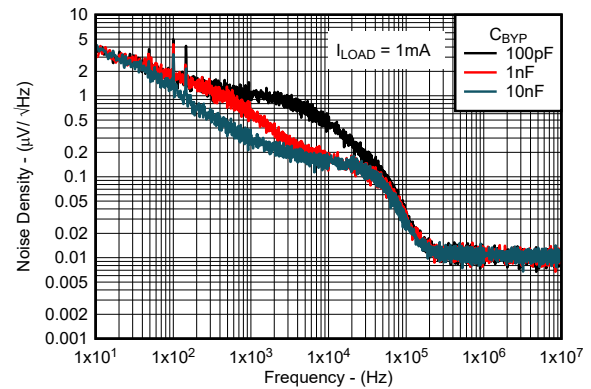


Figure 5-22. Output Noise Density vs Frequency (New Chip)

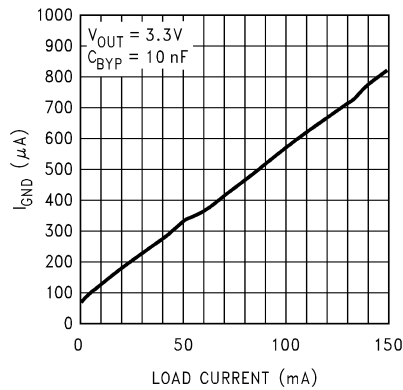


Figure 5-23. Ground Pin vs Load Current (Legacy Chip)

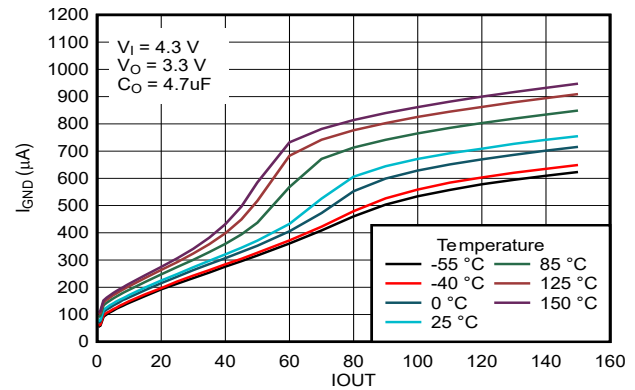


Figure 5-24. Ground Pin Current vs Load Current (New Chip)

## 5.6 Typical Characteristics (continued)



Figure 5-25. Dropout Voltage vs Temperature (Legacy Chip)



Figure 5-26. Dropout Voltage vs Temperature (New Chip)

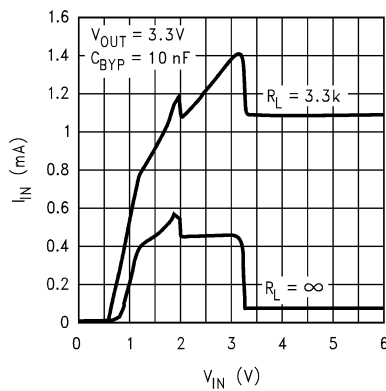
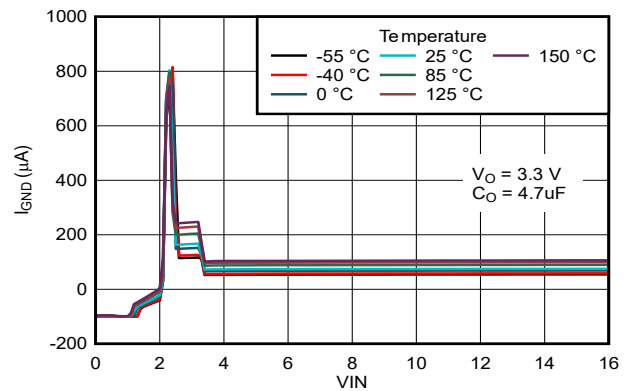
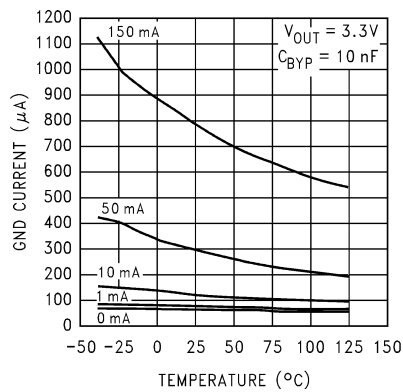
Figure 5-27. Input Current vs  $V_{IN}$  (Legacy Chip)Figure 5-28. Input Current vs  $V_{IN}$  (New Chip)

Figure 5-29. GND Pin Current vs Temperature (Legacy Chip)

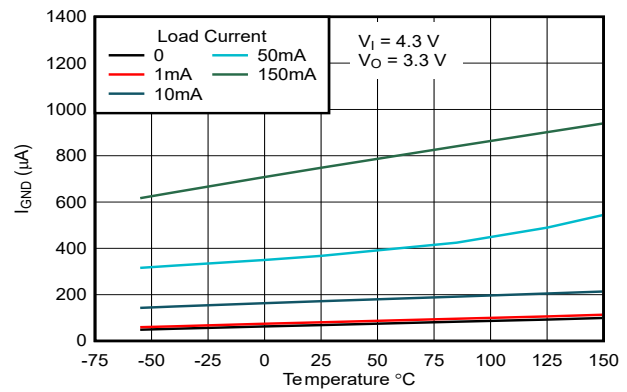


Figure 5-30. GND Pin Current vs Temperature (New Chip)

## 5.6 Typical Characteristics (continued)



Figure 5-31. Instantaneous Short-Circuit Current (Legacy Chip)



Figure 5-32. Short-Circuit Current vs Temperature (New Chip)

## 6 Detailed Description

### 6.1 Overview

The LP2985-N is a fixed-output, low-noise, high PSRR, low-dropout regulator that offers exceptional, cost-effective performance for both portable and nonportable applications. The LP2985-N has an output tolerance of  $\pm 1\%$  across load, and temperature variation (for the new chip) and is capable of delivering 150mA of continuous load current.

This device features integrated overcurrent protection, thermal shutdown, and output enable. The LP2985-N (new chip) has an internal output pulldown and a built-in soft-start mechanism for controlled inrush current. This device delivers excellent line and load transient performance. The operating ambient temperature range of the device is from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### 6.2 Functional Block Diagrams



Figure 6-1. Block Diagram for Legacy Chip

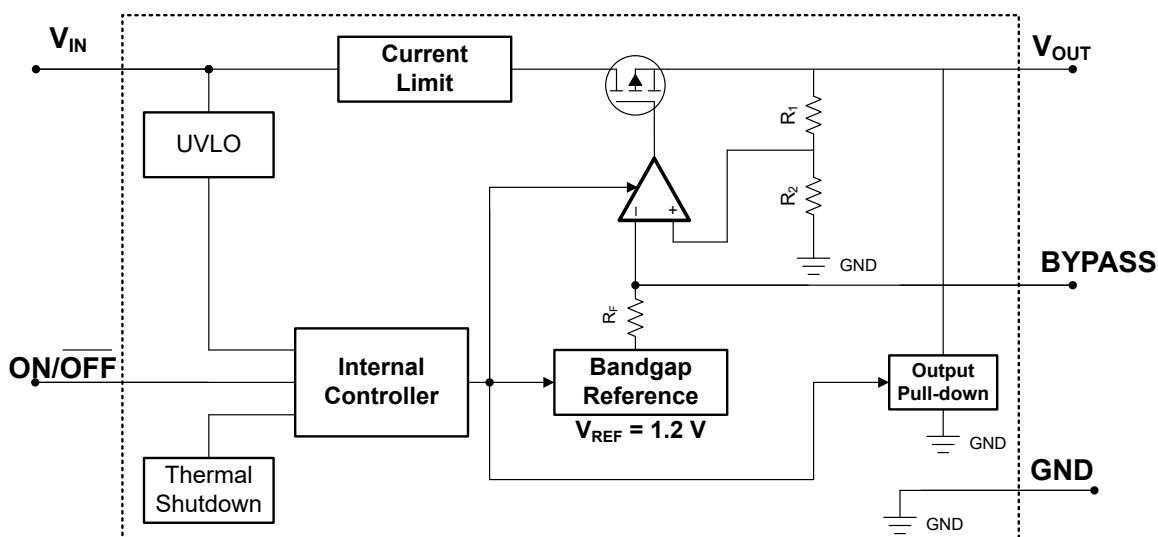


Figure 6-2. Block Diagram for New Chip

## 6.3 Feature Description

### 6.3.1 Output Enable

The ON/ $\overline{\text{OFF}}$  pin for the device is an active-high pin. The output voltage is enabled when the voltage of the ON/ $\overline{\text{OFF}}$  pin is greater than the high-level input voltage of the ON/ $\overline{\text{OFF}}$  pin and disabled with the ON/ $\overline{\text{OFF}}$  pin voltage is less than the low-level input voltage of the ON/ $\overline{\text{OFF}}$  pin. If independent control of the output voltage is not needed, connect the ON/ $\overline{\text{OFF}}$  pin to the input of the device.

The device has an internal pulldown circuit that activates when the device is disabled by pulling the ON/ $\overline{\text{OFF}}$  pin voltage lower than the low-level input voltage of the ON/ $\overline{\text{OFF}}$  pin to actively discharge the output voltage.

### 6.3.2 Dropout Voltage

Dropout voltage ( $V_{\text{DO}}$ ) is defined as the input voltage minus the output voltage ( $V_{\text{IN}} - V_{\text{OUT}}$ ) at the rated output current ( $I_{\text{RATED}}$ ), where the pass transistor is fully on.  $I_{\text{RATED}}$  is the maximum  $I_{\text{OUT}}$  listed in the [Recommended Operating Conditions](#) table. The pass transistor is in the ohmic or triode region of operation, and acts as a switch. The dropout voltage indirectly specifies a minimum input voltage greater than the nominal programmed output voltage at which the output voltage is expected to stay in regulation. If the input voltage falls to less than the nominal output regulation, then the output voltage falls as well.

For a CMOS regulator, the dropout voltage is determined by the drain-source on-state resistance ( $R_{\text{DS(ON)}}$ ) of the pass transistor. Therefore, if the linear regulator operates at less than the rated current, the dropout voltage for that current scales accordingly. The following equation calculates the  $R_{\text{DS(ON)}}$  of the device.

$$R_{\text{DS(ON)}} = \frac{V_{\text{DO}}}{I_{\text{RATED}}} \quad (1)$$

### 6.3.3 Current Limit

For the legacy chip, the internal current limit circuit protects the LDO against high-load current faults or shorting events. The LDO is not designed to operate in a steady-state current limit. During a current-limit event, the LDO sources constant current. Therefore, the output voltage falls when load impedance decreases. If a current limit occurs and the resulting output voltage is low, excessive power is potentially dissipated across the LDO, resulting in a thermal shutdown of the output. A foldback feature limits the short-circuit current to protect the regulator from damage under all load conditions. If  $V_{\text{OUT}}$  is forced below 0V before EN goes high and the load current required exceeds the foldback current limit, the device potentially does not start up correctly.

For the new chip, the device has an internal current limit circuit that protects the regulator during transient high-load current faults or shorting events. The current limit is a brick-wall scheme. In a high-load current fault, the brick-wall scheme limits the output current to the current limit ( $I_{\text{CL}}$ ).  $I_{\text{CL}}$  is listed in the [Electrical Characteristics](#) table.

The output voltage is not regulated when the device is in current limit. When a current limit event occurs, the device begins to heat up because of the increase in power dissipation. When the device is in brick-wall current limit, the pass transistor dissipates power  $[(V_{\text{IN}} - V_{\text{OUT}}) \times I_{\text{CL}}]$ . If thermal shutdown is triggered, the device turns off. After the device cools down, the internal thermal shutdown circuit turns the device back on. If the output current fault condition continues, the device cycles between current limit and thermal shutdown. For more information on current limits, see the [Know Your Limits application note](#).

Figure 6-3 shows a diagram of the current limit.



Figure 6-3. Current Limit

### 6.3.4 Undervoltage Lockout (UVLO)

The device has an independent undervoltage lockout (UVLO) circuit that monitors the input voltage, allowing a controlled and consistent turn on and off of the output voltage. To prevent the device from turning off if the input drops during turn on, the UVLO has hysteresis as specified in the [Electrical Characteristics](#) table.

### 6.3.5 Output Pulldown

The new chip has an output pulldown circuit. The output pulldown activates in the following conditions:

- When the device is disabled ( $V_{ON/OFF} < V_{ON/OFF(LOW)}$ )
- If  $1.0V < V_{IN} < V_{UVLO}$

Do not rely on the output pulldown circuit for discharging a large amount of output capacitance after the input supply has collapsed because reverse current can flow from the output to the input. This reverse current flow can cause damage to the device. See the [Reverse Current](#) section for more details.

### 6.3.6 Thermal Shutdown

The device contains a thermal shutdown protection circuit to disable the device when the junction temperature ( $T_J$ ) of the pass transistor rises to  $T_{SD(shutdown)}$  (typical). Thermal shutdown hysteresis makes sure the device resets (turns on) when the temperature falls to  $T_{SD(reset)}$  (typical).

The thermal time-constant of the semiconductor die is fairly short, thus the device can cycle on and off when thermal shutdown is reached until power dissipation is reduced. Power dissipation during start up can be high from large  $V_{IN} - V_{OUT}$  voltage drops across the device or from high inrush currents charging large output capacitors. Under some conditions, the thermal shutdown protection disables the device before start up completes.

For reliable operation, limit the junction temperature to the maximum listed in the [Recommended Operating Conditions](#) table. Operation above this maximum temperature causes the device to exceed operational specifications. Although the internal protection circuitry of the device is designed to protect against thermal overall conditions, this circuitry is not intended to replace proper heat sinking. Continuously running the device into thermal shutdown or above the maximum recommended junction temperature reduces long-term reliability.

## 6.4 Device Functional Modes

Table 6-1 shows the conditions that lead to the different modes of operation. See the [Electrical Characteristics](#) table for parameter values.

**Table 6-1. Device Functional Mode Comparison**

| OPERATING MODE                                       | PARAMETER                                                   |                                |                          |                          |
|------------------------------------------------------|-------------------------------------------------------------|--------------------------------|--------------------------|--------------------------|
|                                                      | $V_{IN}$                                                    | $V_{ON/OFF}$                   | $I_{OUT}$                | $T_J$                    |
| Normal operation                                     | $V_{IN} > V_{OUT(nom)} + V_{DO}$ and $V_{IN} > V_{IN(min)}$ | $V_{ON/OFF} > V_{ON/OFF(HI)}$  | $I_{OUT} < I_{OUT(max)}$ | $T_J < T_{SD(shutdown)}$ |
| Dropout operation                                    | $V_{IN(min)} < V_{IN} < V_{OUT(nom)} + V_{DO}$              | $V_{ON/OFF} > V_{ON/OFF(HI)}$  | $I_{OUT} < I_{OUT(max)}$ | $T_J < T_{SD(shutdown)}$ |
| Disabled<br>(any true condition disables the device) | $V_{IN} < V_{UVLO}$                                         | $V_{ON/OFF} < V_{ON/OFF(LOW)}$ | Not applicable           | $T_J > T_{SD(shutdown)}$ |

### 6.4.1 Normal Operation

The device regulates to the nominal output voltage when the following conditions are met:

- The input voltage is greater than the nominal output voltage plus the dropout voltage ( $V_{OUT(nom)} + V_{DO}$ )
- The output current is less than the current limit ( $I_{OUT} < I_{CL}$ )
- The device junction temperature is less than the thermal shutdown temperature ( $T_J < T_{SD}$ )
- The ON/OFF voltage has previously exceeded the ON/OFF rising threshold voltage and has not yet decreased to less than the enable falling threshold

### 6.4.2 Dropout Operation

If the input voltage is lower than the nominal output voltage plus the specified dropout voltage, but all other conditions are met for normal operation, the device operates in dropout mode. In this mode, the output voltage tracks the input voltage. During this mode, the transient performance of the device becomes significantly degraded because the pass transistor is in the ohmic or triode region, and acts as a switch. Line or load transients in dropout can result in large output voltage deviations.

When the device is in a steady dropout state (defined as when the device is in dropout,  $V_{IN} < V_{OUT(NOM)} + V_{DO}$ , directly after being in a normal regulation state, but *not* during start up), the pass transistor is driven into the ohmic or triode region. When the input voltage returns to a value greater than or equal to the nominal output voltage plus the dropout voltage ( $V_{OUT(NOM)} + V_{DO}$ ), the output voltage can overshoot for a short period of time while the device pulls the pass transistor back into the linear region.

### 6.4.3 Disabled

The output of the device can be shutdown by forcing the voltage of the ON/OFF pin to less than the maximum ON/OFF pin low-level input voltage (see the [Electrical Characteristics](#) table). When disabled, the pass transistor is turned off, internal circuits are shutdown, and the output voltage is actively discharged to ground by an internal discharge circuit from the output to ground.

## 7 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 7.1 Application Information

The LP2985-N is a linear voltage regulator operating from 2.5V to 16V on the input and regulates voltages between 1.2V to 5V (new chip) with 1% accuracy across line, load and temperature (new chip) and 150mA maximum output current. The LP2985-N low output noise of  $30\mu\text{V}_{\text{RMS}}$  (with 10nF bypass capacitors) and wide bandwidth PSRR performance of greater than 70dB at 1kHz and 40dB at 1MHz help attenuate the switching frequency of an upstream DC/DC converter and minimize post regulator filtering.

#### 7.1.1 Recommended Capacitor Types

##### 7.1.1.1 Recommended Capacitors (Legacy Chip)

The LP2985-N is designed to work with ceramic capacitors on the output to take advantage of the benefits these capacitors offer. For capacitance values in the  $2.2\mu\text{F}$  to  $4.7\mu\text{F}$  range, ceramics are the least expensive and also have the lowest ESR values. Thus, these components are the most efficient at eliminating high-frequency noise. The ESR of a typical  $2.2\mu\text{F}$  ceramic capacitor is in the range of  $10\text{m}\Omega$  to  $20\text{m}\Omega$ . This range easily meets the ESR limits required for stability by the LP2985-N.

One disadvantage of ceramic capacitors is that the capacitance varies with temperature. Most large-value ceramic capacitors ( $\geq 2.2\mu\text{F}$ ) are manufactured with the Z5U or Y5V temperature characteristic. Thus, resulting in the capacitance dropping by more than 50% as the temperature goes from  $25^\circ\text{C}$  to  $85^\circ\text{C}$ .

This capacitance drop potentially cause problems if a  $2.2\mu\text{F}$  capacitor is used on the output because that capacitor goes down to approximately  $1\mu\text{F}$  at high ambient temperatures. Such low capacitance causes the LP2985-N to oscillate. If Z5U or Y5V capacitors are used on the output, adhere to a minimum capacitance value of  $2.2\mu\text{F}$ .

A better choice for temperature coefficient in ceramic capacitors is X7R, which holds the capacitance within  $\pm 15\%$ . Unfortunately, the larger values of capacitance are not offered by all manufacturers in the X7R dielectric.

Tantalum capacitors are less desirable than ceramics for use as output capacitors. These components are more expensive when comparing equivalent capacitance and voltage ratings in the  $1\mu\text{F}$  to  $4.7\mu\text{F}$  range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. Which means that although a tantalum capacitor potentially has an ESR value within the stable range, the capacitor is larger in capacitance. Thus, the tantalum capacitor is bigger and more costly than a ceramic capacitor with the same ESR value.

The ESR of a typical tantalum increases by approximately 2:1 as the temperature goes from  $25^\circ\text{C}$  down to  $-40^\circ\text{C}$ , so some allow for guard band.

##### 7.1.1.2 Recommended Capacitors (New Chip)

The new chip is designed to be stable using low equivalent series resistance (ESR) ceramic capacitors at the input and output. Multilayer ceramic capacitors have become the industry standard for these types of applications and are recommended, but use good judgment. Ceramic capacitors that employ X7R-, X5R-, and C0G-rated dielectric materials provide relatively good capacitive stability across temperature. However, using Y5V-rated capacitors is discouraged because of large variations in capacitance.

Maximum supported ESR range across complete temperature ( $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ ) and load current range (0mA-150mA) is less than  $1\Omega$ . If in an existing implementation where different type of capacitors with higher

ESR are used, use a low-ESR, 100nF MLCC capacitor. Place this capacitor as close as possible to the device output pin ( $V_{OUT}$ ).

Regardless of the ceramic capacitor type selected, the effective capacitance varies with operating voltage and temperature. Generally, expect the effective capacitance to decrease by as much as 50%. The input and output capacitors listed in the [Recommended Operating Conditions](#) table account for an effective capacitance of approximately 50% of the nominal value.

### 7.1.2 Input Capacitor Requirements

For legacy chip, an input capacitor whose capacitance is  $\geq 1\mu\text{F}$  is required between the LP2985-N input and ground (increase the amount of capacitance without limit). Place this capacitor no more than 1cm from the input pin and make sure the capacitor returns to a clean analog ground. Use any good-quality ceramic, tantalum, or film capacitor at the input.

#### Note

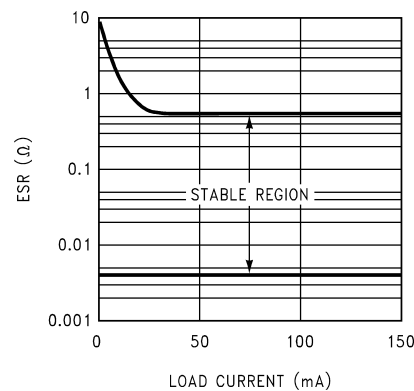
Tantalum capacitors can suffer catastrophic failure because of surge current when connected to a low-impedance source of power (such as a battery or very large capacitor). If a tantalum capacitor is used at the input, contact the manufacturer to make sure the capacitor has a surge current rating sufficient for the application.

There are no requirements for ESR on the input capacitor, but consider tolerance and temperature coefficient when selecting the capacitor to make sure the capacitance is  $\geq 1\mu\text{F}$  over the entire operating temperature range.

For new chip, although an input capacitor is not required for stability, good analog design practice is to connect a capacitor from IN to GND. This capacitor counteracts reactive input sources and improves transient response, input ripple, and PSRR. Use an input capacitor if the source impedance is more than  $0.5\Omega$ . A higher value capacitor can be necessary if large, fast rise-time load or line transients are anticipated or if the device is located several inches from the input power source.

### 7.1.3 Output Capacitor Requirements

The LP2985-N (legacy chip) is designed specifically to work with ceramic output capacitors, using circuitry which allows the regulator to be stable across the entire range of output current with an output capacitor whose ESR is as low as  $5\text{m}\Omega$ . Using tantalum or film capacitors is also possible at the output, but these are not as attractive for reasons of size and cost (see the [Recommended Capacitors \(Legacy Chip\)](#) section). The output capacitor must meet the requirement for minimum amount of capacitance and also have an ESR value which is within the stable range. Curves are provided which show the stable ESR range as a function of load current (see [Figure 7-1](#)).



**Figure 7-1. ESR Graph (Legacy Chip)**

---

**Note**

The output capacitor must maintain the ESR within the stable region over the full operating temperature range of the application to provide stability.

The LP2985-N requires a minimum of 2.2 $\mu$ F on the output (output capacitor size can be increased without limit).

---

Remember that capacitor tolerance and variation with temperature must be taken into consideration when selecting an output capacitor so that the minimum required amount of output capacitance is provided over the full operating temperature range. Ceramic capacitors can exhibit large changes in capacitance with temperature (see the [Recommended Capacitors \(Legacy Chip\)](#) section). The output capacitor must be located not more than 1cm from the output pin and returned to a clean analog ground.

For the new chip, dynamic performance of the device is improved with the use of an output capacitor. Use an output capacitor within the range specified in the [Recommended Operating Conditions](#) table for stability.

**7.1.4 Noise Bypass Capacitor ( $C_{BYPASS}$ )**

The LP2985-N allows for low-noise performance by using a bypass capacitor connected to the internal band-gap reference with the BYPASS pin. This high-impedance band-gap circuitry is biased in the microampere range and, thus, cannot be loaded significantly, otherwise, the output (and, correspondingly, the output of the regulator) changes. Thus, for best output accuracy, minimize the dc leakage current through  $C_{BYPASS}$  as much as possible and never exceed 100nA. The  $C_{BYPASS}$  capacitor also impacts the start-up behavior of the regulator. Inrush current and start-up time increase with larger bypass capacitor values.

Use a 10nF capacitor for  $C_{BYPASS}$ . Ceramic and film capacitors are good choices for this purpose. High-quality ceramic capacitors with either NPO or COG dielectric typically have very low leakage. 10nF polypropylene and polycarbonate film capacitors are available in small surface-mount packages and typically have extremely low leakage current.

### 7.1.5 Reverse Current

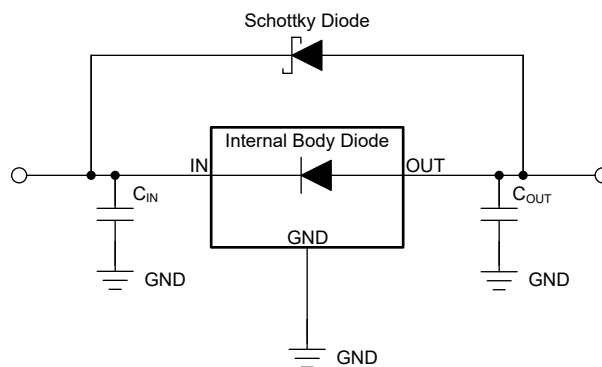
Excessive reverse current can damage this device. Reverse current flows through the intrinsic body diode of the pass transistor instead of the normal conducting channel. At high magnitudes, this current flow degrades the long-term reliability of the device.

Conditions where reverse current can occur are outlined in this section, all of which can exceed the absolute maximum rating of  $V_{OUT} \leq V_{IN} + 0.3V$ .

- If the device has a large  $C_{OUT}$  and the input supply collapses with little or no load current
- The output is biased when the input supply is not established
- The output is biased above the input supply

If reverse current flow is expected in the application, use external protection to protect the device. Reverse current is not limited in the device, so external limiting is required if extended reverse voltage operation is anticipated.

Figure 7-2 shows one approach for protecting the device.



**Figure 7-2. Example Circuit for Reverse Current Protection Using a Schottky Diode**

### 7.1.6 Power Dissipation ( $P_D$ )

Circuit reliability requires consideration of the device power dissipation, location of the circuit on the printed circuit board (PCB), and correct sizing of the thermal plane. The PCB area around the regulator must have few or no other heat-generating devices that cause added thermal stress.

To first-order approximation, power dissipation in the regulator depends on the input-to-output voltage difference and load conditions. The following equation calculates power dissipation ( $P_D$ ).

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (2)$$

#### Note

Power dissipation can be minimized, and therefore greater efficiency can be achieved, by correct selection of the system voltage rails. For the lowest power dissipation use the minimum input voltage required for correct output regulation.

For devices with a thermal pad, the primary heat conduction path for the device package is through the thermal pad to the PCB. Solder the thermal pad to a copper pad area under the device. This pad area must contain an array of plated vias that conduct heat to additional copper planes for increased heat dissipation.

The maximum power dissipation determines the maximum allowable ambient temperature ( $T_A$ ) for the device. According to the following equation, power dissipation and junction temperature are most often related by the junction-to-ambient thermal resistance ( $R_{\theta JA}$ ) of the combined PCB and device package and the temperature of the ambient air ( $T_A$ ).

$$T_J = T_A + (R_{\theta JA} \times P_D) \quad (3)$$

Thermal resistance ( $R_{\theta JA}$ ) is highly dependent on the heat-spreading capability built into the particular PCB design, and therefore varies according to the total copper area, copper weight, and location of the planes. The junction-to-ambient thermal resistance listed in the [Thermal Information](#) table is determined by the JEDEC standard PCB and copper-spreading area, and is used as a relative measure of package thermal performance.

### 7.1.7 Estimating Junction Temperature

The JEDEC standard now recommends the use of psi ( $\Psi$ ) thermal metrics to estimate the junction temperatures of the linear regulator when in-circuit on a typical PCB board application. These metrics are not thermal resistance parameters and instead offer a practical and relative way to estimate junction temperature. These psi metrics are determined to be significantly independent of the copper area available for heat-spreading. The [Thermal Information](#) table lists the primary thermal metrics, which are the junction-to-top characterization parameter ( $\psi_{JT}$ ) and junction-to-board characterization parameter ( $\psi_{JB}$ ). These parameters provide two methods for calculating the junction temperature ( $T_J$ ), as described in the following equations. Use the junction-to-top characterization parameter ( $\psi_{JT}$ ) with the temperature at the center-top of device package ( $T_T$ ) to calculate the junction temperature. Use the junction-to-board characterization parameter ( $\psi_{JB}$ ) with the PCB surface temperature 1 mm from the device package ( $T_B$ ) to calculate the junction temperature.

$$T_J = T_T + \psi_{JT} \times P_D \quad (4)$$

where:

- $P_D$  is the dissipated power
- $T_T$  is the temperature at the center-top of the device package

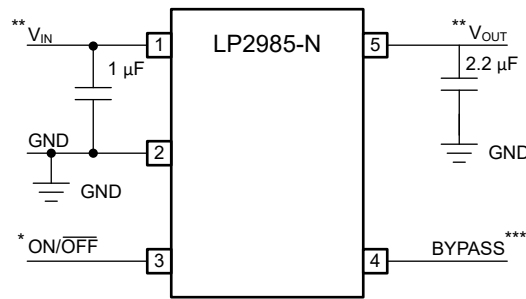
$$T_J = T_B + \psi_{JB} \times P_D \quad (5)$$

where:

- $T_B$  is the PCB surface temperature measured 1 mm from the device package and centered on the package edge

For detailed information on the thermal metrics and how to use them, see the [Semiconductor and IC Package Thermal Metrics application note](#).

## 7.2 Typical Application



\*The ON/OFF input must be actively terminated. Tie to  $V_{IN}$  if this function is not used. \*\*Minimum capacitance is shown to provide stability (can be increased without limit). Ceramic capacitor required for output (see the [Input Capacitor Requirements](#) and [Output Capacitor Requirements](#) sections). \*\*\*Reduces output noise (can be omitted if application is not noise critical). Use ceramic or film type with very low leakage current (see the [Noise Bypass Capacitor \( \$C\_{BYPASS}\$ \)](#) section).

**Figure 7-3. Typical Application Schematic**

### 7.2.1 Design Requirements

[Table 7-1](#) lists the typical design parameters.

**Table 7-1. Design Parameters for the New Chip**

| DESIGN PARAMETERS         | VALUE                                                              |
|---------------------------|--------------------------------------------------------------------|
| Input voltage             | 4.3V, $\pm 10\%$ provided by the DC/DC converter switching at 1MHz |
| Output voltage            | 3.3V, $\pm 1\%$                                                    |
| Output current            | 0mA–150mA (maximum)                                                |
| RMS noise, 300Hz to 50kHz | $< 30\mu V_{RMS}$                                                  |
| PSRR at 100kHz            | $> 40dB$                                                           |

### 7.2.2 Detailed Design Procedure

#### 7.2.2.1 ON/OFF Input Operation

The LP2985-N is shut off by driving the ON/OFF input low, and turned on by pulling the ON/OFF input high. If this feature is not used, the ON/OFF input must be tied to  $V_{IN}$  to keep the regulator output on at all times.

To provide proper operation, the signal source used to drive the ON/OFF input must be able to swing above and below the specified turn-on and turn-off voltage thresholds listed in the [Electrical Characteristics](#) table under  $V_{ON/OFF}$ .

For the legacy chip, to prevent misoperation, the turn-on (and turn-off) voltage signals applied to the ON/OFF input must have a slew rate that is  $\geq 40mV/\mu s$ . But for the new chip, there is no restriction on the slew rate of the voltage signals applied to the ON/OFF pin.

### 7.2.3 Application Curves

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)

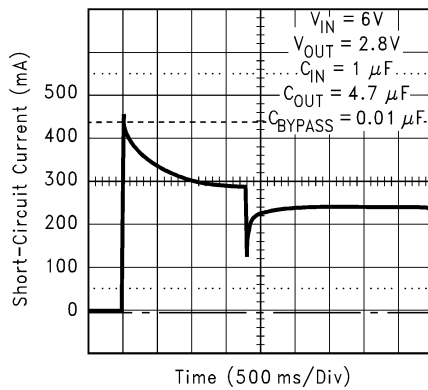


Figure 7-4. Short-Circuit Current (Legacy Chip) at  $V_{IN} = 6\text{V}$

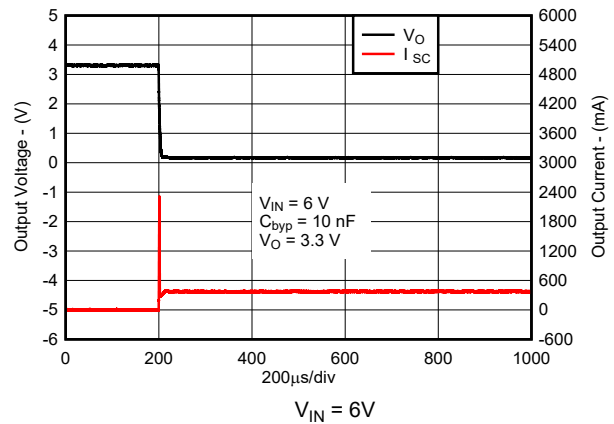


Figure 7-5. Short-Circuit Current (New Chip) at  $V_{IN} = 6\text{V}$

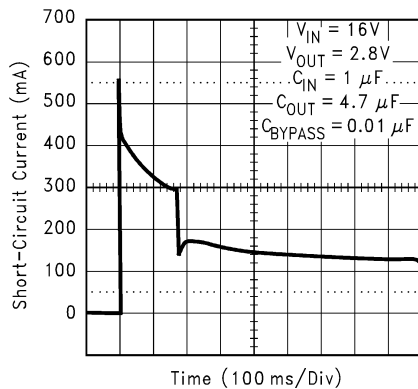


Figure 7-6. Short-Circuit Current (Legacy Chip) at  $V_{IN} = 16\text{V}$

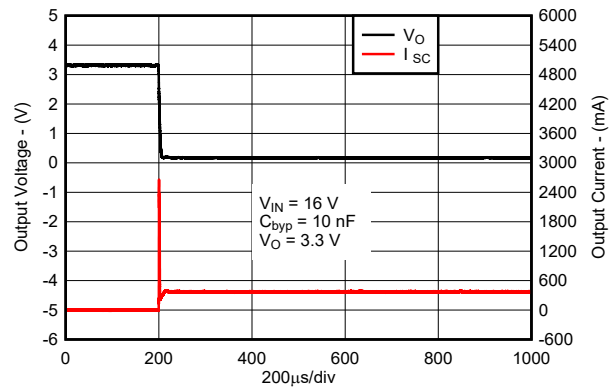


Figure 7-7. Short-Circuit Current (New Chip) at  $V_{IN} = 16\text{V}$

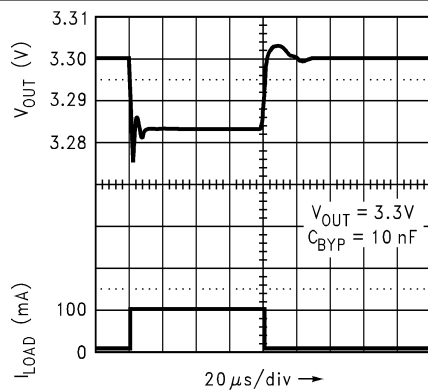


Figure 7-8. Load Transient Response (Legacy Chip)

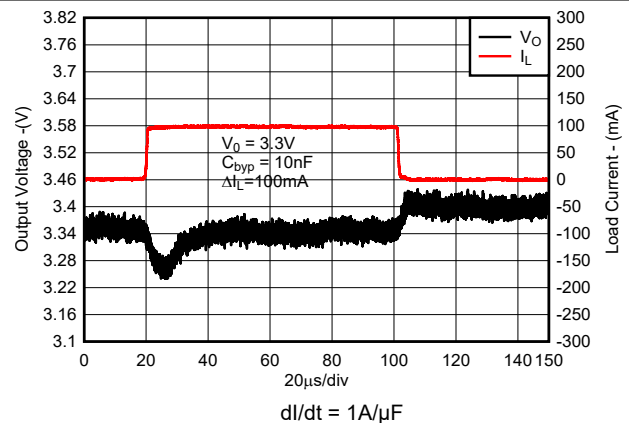


Figure 7-9. Load Transient Response (New Chip)

### 7.2.3 Application Curves (continued)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)

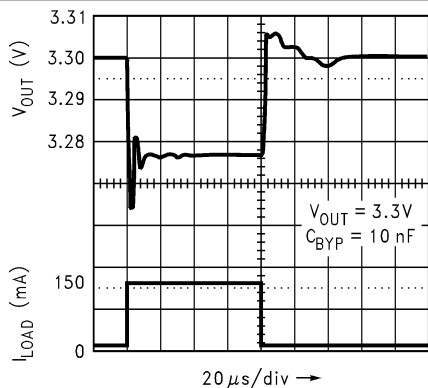


Figure 7-10. Load Transient Response (Legacy Chip)

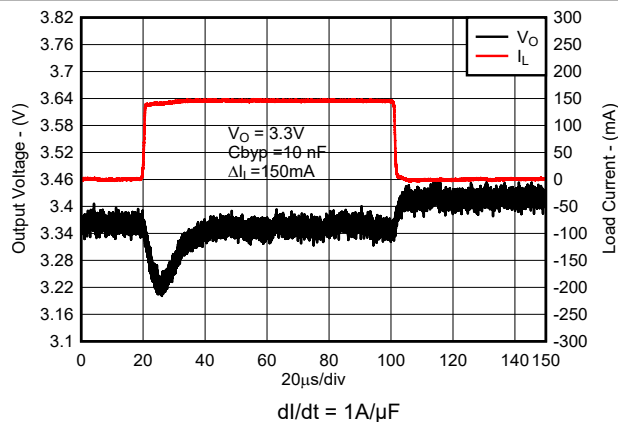


Figure 7-11. Load Transient (New Chip)

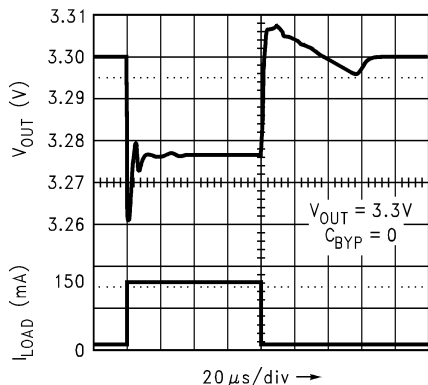


Figure 7-12. Load Transient Response (Legacy Chip)

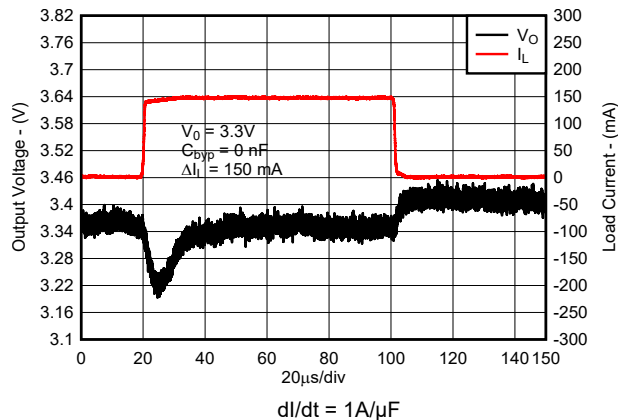


Figure 7-13. Load Transient Response (New Chip)

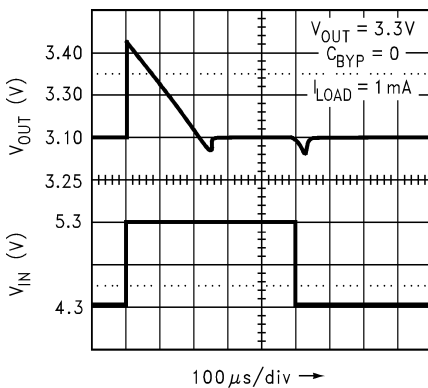


Figure 7-14. Line Transient Response (Legacy Chip)

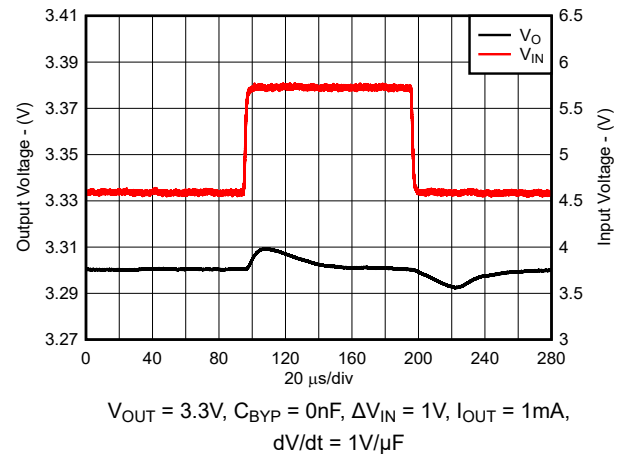


Figure 7-15. Line Transient Response (New Chip)

### 7.2.3 Application Curves (continued)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)



Figure 7-16. Line Transient Response (Legacy Chip)



Figure 7-17. Line Transient Response (New Chip)



Figure 7-18. Line Transient Response (Legacy Chip)

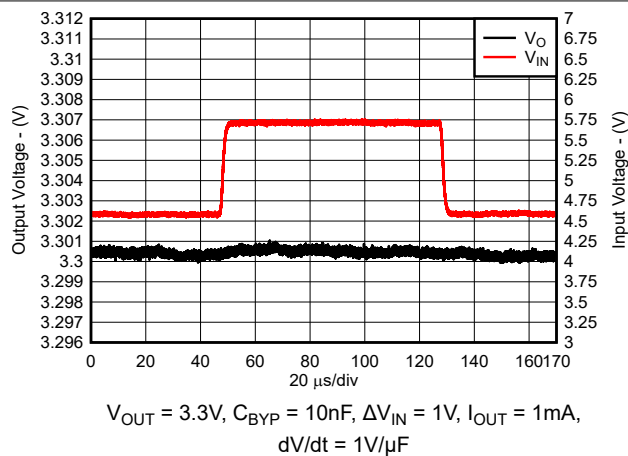


Figure 7-19. Line Transient Response (New Chip)



Figure 7-20. Line Transient Response (Legacy Chip)



Figure 7-21. Line Transient Response (New Chip)

### 7.2.3 Application Curves (continued)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)

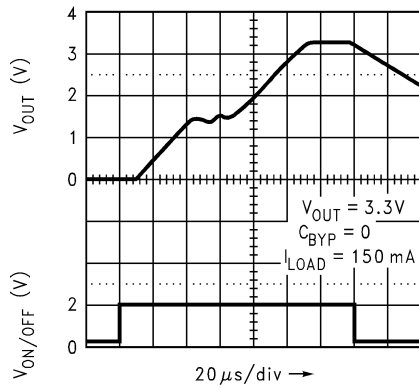


Figure 7-22. Turn-On Time (Legacy Chip)

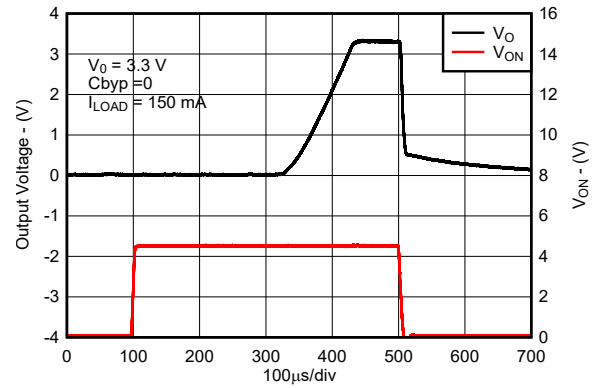


Figure 7-23. Turn-On Time (New Chip)

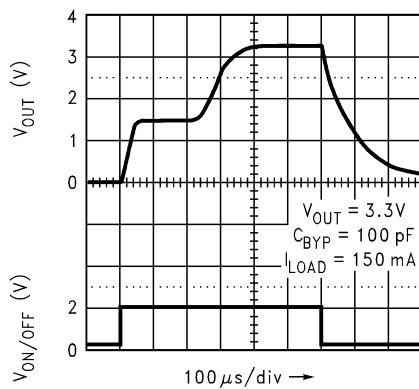


Figure 7-24. Turn-On Time (Legacy Chip)

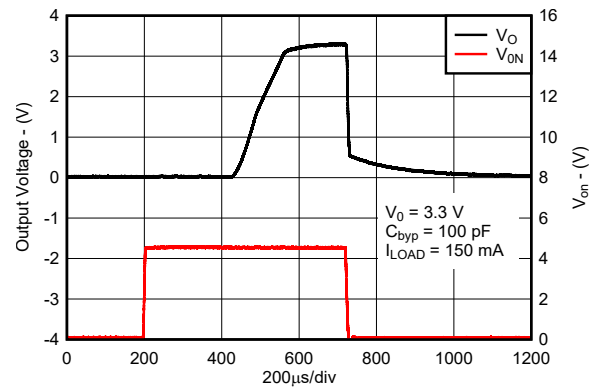


Figure 7-25. Turn-On Time (New Chip)

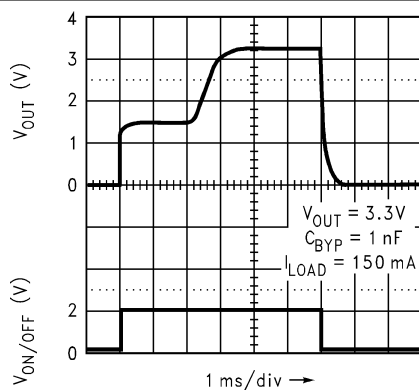


Figure 7-26. Turn-On Time (Legacy Chip)

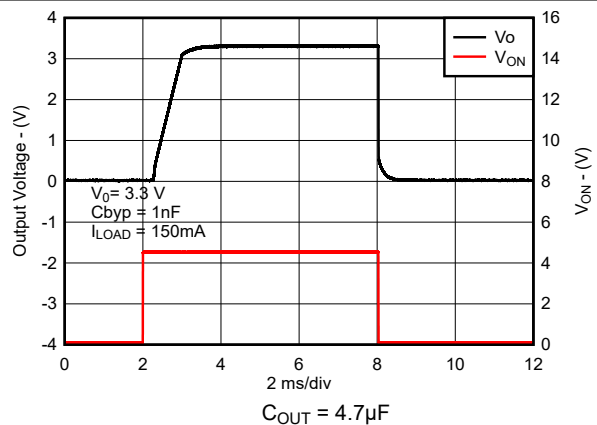


Figure 7-27. Turn-On Time (New Chip)

### 7.2.3 Application Curves (continued)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$  or  $2.5\text{V}$  (whichever is greater),  $I_{OUT} = 1\text{mA}$ , ON/OFF pin tied to  $V_{IN}$ ,  $C_{IN} = 1.0\mu\text{F}$ , and  $C_{OUT} = 4.7\mu\text{F}$  (unless otherwise noted)

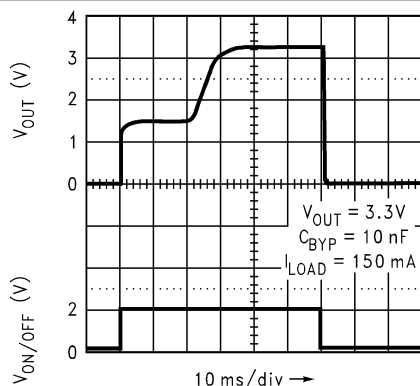


Figure 7-28. Turn-On Time (Legacy Chip)

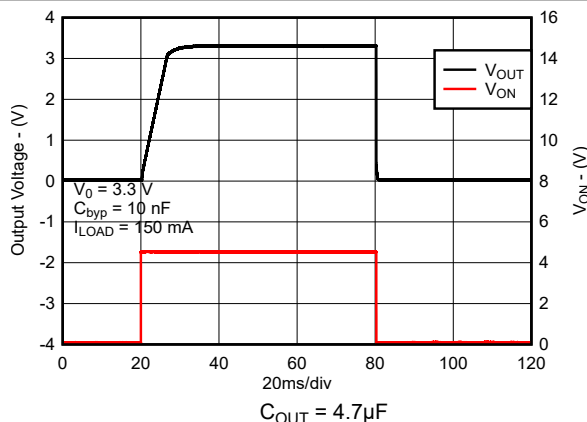


Figure 7-29. Turn-On Time (New Chip)

## 7.3 Power Supply Recommendations

A power supply can be used at the input voltage within the ranges given in the [Recommended Operating Conditions](#) table. Use bypass capacitors as described in the [Layout Guidelines](#) section.

## 7.4 Layout

### 7.4.1 Layout Guidelines

For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close as possible to each other, connected by a wide, component-side, copper surface. The use of vias and long traces to create LDO circuit connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability.

A ground reference plane is also recommended and is either embedded in the PCB or located on the bottom side of the PCB opposite the components. This reference plane serves to maintain accuracy of the output voltage, shield noise, and behaves similar to a thermal plane to spread (or sink) heat from the LDO device. In most applications, this ground plane is necessary to meet thermal requirements.

### 7.4.2 Layout Example



Figure 7-30. LP2985 SOT-23 Package Typical Layout

## 8 Device and Documentation Support

### 8.1 Documentation Support

#### 8.1.1 Related Documentation

- Texas Instruments, [Semiconductor and IC Package Thermal Metrics](#) application note
- Texas Instruments, [Using New Thermal Metrics](#) application note
- Texas Instruments, [Thermal Characteristics of Linear and Logic Packages Using JEDEC PCB Designs](#) application note

### 8.2 Device Nomenclature

**Table 8-1. Available Options**

| PRODUCT <sup>(1)</sup>                                  | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|---------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p>LP2985vwxy-z.z/NOPB<br/>or<br/>LP2985vwxy-z.z/M3</p> | <p><b>v</b> is the accuracy specification for the legacy chip (A or blank). See the <a href="#">Section 5.5</a> for more information. This character is insignificant for the new chip. <b>w</b> is the operating temperature range (I = –40°C to +125°C). <b>xx</b> is the package designator (for example, M5 = SOT-23). <b>y</b> is the reel designator size. See Package Addendum for more information on package quantity. <b>z.z</b> is the nominal output voltage (for example, 3.3 = 3.3V; 5.0 = 5.0V). <b>/NOPB</b> indicates material construction that does not use Lead (Pb). This device ships with either the legacy chip (CSO: DLN or GF8) or the new chip (CSO:RFB), which uses the latest manufacturing flow. The reel packaging label provides CSO information to distinguish which chip is used. Device performance for new and legacy chips is denoted throughout the document. <b>M3</b> is a suffix designator only significant for the new chip with CSO:RFB, which uses the latest manufacturing flow.</p> |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at [www.ti.com](http://www.ti.com).

### 8.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 8.4 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 8.5 Trademarks

TI E2E™ is a trademark of Texas Instruments.  
All trademarks are the property of their respective owners.

### 8.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 8.7 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision AA (July 2023) to Revision AB (June 2025)</b>                                               | <b>Page</b>        |
|----------------------------------------------------------------------------------------------------------------------|--------------------|
| • Changed <i>Description</i> section to identify new chip information.....                                           | <a href="#">1</a>  |
| • Changed <i>Overview</i> section to identify new chip information.....                                              | <a href="#">14</a> |
| • Changed <i>Current Limit</i> section.....                                                                          | <a href="#">15</a> |
| • Changed <i>Recommended Capacitor Types</i> section and added new chip and legacy chip subsections.....             | <a href="#">18</a> |
| • Added <i>Input Capacitor Requirements</i> section.....                                                             | <a href="#">19</a> |
| • Added high-quality ceramic capacitor discussion to <i>Noise Bypass Capacitor (C<sub>BYPASS</sub>)</i> section..... | <a href="#">20</a> |
| • Deleted <i>Capacitor Characteristics</i> section.....                                                              | <a href="#">23</a> |
| • Changed <i>ON/OFF Input Operation</i> section.....                                                                 | <a href="#">23</a> |
| • Changed <i>Available Options</i> table.....                                                                        | <a href="#">29</a> |

| <b>Changes from Revision Z (May 2023) to Revision AA (July 2023)</b>                                                                   | <b>Page</b>       |
|----------------------------------------------------------------------------------------------------------------------------------------|-------------------|
| • Widening I <sub>GND</sub> spec limits to accommodate complete V <sub>OUT</sub> range in <i>Electrical Characteristics</i> table..... | <a href="#">4</a> |

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number               | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| LP2985AIM5-2.5/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUA                |
| <a href="#">LP2985AIM5-2.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LAUA                |
| LP2985AIM5-2.7/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LALA                |
| <a href="#">LP2985AIM5-2.7/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LALA                |
| LP2985AIM5-2.8/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0KA                |
| <a href="#">LP2985AIM5-2.8/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0KA                |
| LP2985AIM5-2.9/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXA                |
| <a href="#">LP2985AIM5-2.9/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXA                |
| LP2985AIM5-3.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| LP2985AIM5-3.0/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| <a href="#">LP2985AIM5-3.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| LP2985AIM5-3.1/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PA                |
| <a href="#">LP2985AIM5-3.1/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PA                |
| LP2985AIM5-3.3/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RA                |
| <a href="#">LP2985AIM5-3.3/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RA                |
| LP2985AIM5-3.6/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5-3.6/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| <a href="#">LP2985AIM5-3.6/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5-3.8/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0YA                |
| LP2985AIM5-3.8/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0YA                |
| <a href="#">LP2985AIM5-3.8/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0YA                |
| LP2985AIM5-4.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0TA                |
| <a href="#">LP2985AIM5-4.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0TA                |
| LP2985AIM5-4.5/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LA7A                |
| <a href="#">LP2985AIM5-4.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LA7A                |
| LP2985AIM5-5.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0UA                |
| <a href="#">LP2985AIM5-5.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0UA                |
| LP2985AIM5-5.7/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LKTA                |
| <a href="#">LP2985AIM5-5.7/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | LKTA                |

| Orderable part number                | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| LP2985AIM5-6.1/NO.A                  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6A                |
| <a href="#">LP2985AIM5-6.1/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6A                |
| LP2985AIM5X-2.5/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUA                |
| LP2985AIM5X-2.5/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUA                |
| <a href="#">LP2985AIM5X-2.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LAUA                |
| LP2985AIM5X-2.6/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LCEA                |
| <a href="#">LP2985AIM5X-2.6/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LCEA                |
| LP2985AIM5X-2.8/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0KA                |
| <a href="#">LP2985AIM5X-2.8/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0KA                |
| LP2985AIM5X-2.9/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXA                |
| <a href="#">LP2985AIM5X-2.9/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXA                |
| LP2985AIM5X-3.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| LP2985AIM5X-3.0/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| <a href="#">LP2985AIM5X-3.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0OA                |
| LP2985AIM5X-3.1/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PA                |
| <a href="#">LP2985AIM5X-3.1/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PA                |
| LP2985AIM5X-3.3/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RA                |
| <a href="#">LP2985AIM5X-3.3/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RA                |
| <a href="#">LP2985AIM5X-3.6/M3</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5X-3.6/M3.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5X-3.6/M3.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5X-3.6/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5X-3.6/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| <a href="#">LP2985AIM5X-3.6/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0SA                |
| LP2985AIM5X-3.8/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0YA                |
| <a href="#">LP2985AIM5X-3.8/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0YA                |
| LP2985AIM5X-4.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0TA                |
| LP2985AIM5X-4.0/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0TA                |
| <a href="#">LP2985AIM5X-4.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0TA                |
| LP2985AIM5X-4.5/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LA7A                |
| LP2985AIM5X-4.5/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LA7A                |

| Orderable part number                | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LP2985AIM5X-4.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LA7A                |
| LP2985AIM5X-5.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0UA                |
| <a href="#">LP2985AIM5X-5.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0UA                |
| LP2985AIM5X-6.1/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6A                |
| <a href="#">LP2985AIM5X-6.1/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6A                |
| <a href="#">LP2985IM5-2.5/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LAUB                |
| LP2985IM5-2.5/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUB                |
| <a href="#">LP2985IM5-2.7/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | LALB                |
| LP2985IM5-2.7/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LALB                |
| LP2985IM5-2.7/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LALB                |
| <a href="#">LP2985IM5-2.8/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0KB                |
| LP2985IM5-2.8/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0KB                |
| <a href="#">LP2985IM5-2.9/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXB                |
| LP2985IM5-2.9/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXB                |
| LP2985IM5-2.9/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LAXB                |
| <a href="#">LP2985IM5-3.0/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| LP2985IM5-3.0/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| LP2985IM5-3.0/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| <a href="#">LP2985IM5-3.1/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PB                |
| LP2985IM5-3.1/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PB                |
| LP2985IM5-3.1/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0PB                |
| <a href="#">LP2985IM5-3.2/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0QB                |
| LP2985IM5-3.2/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0QB                |
| LP2985IM5-3.2/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0QB                |
| <a href="#">LP2985IM5-3.3/NOM3</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| LP2985IM5-3.3/NOM3.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| <a href="#">LP2985IM5-3.3/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| LP2985IM5-3.3/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| LP2985IM5-3.3/NOPB.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| <a href="#">LP2985IM5-3.5/NOPB</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LAIB                |
| LP2985IM5-3.5/NOPB.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAIB                |

| Orderable part number               | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LP2985IM5-3.6/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | (L0SB, L0YB)        |
| LP2985IM5-3.6/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (L0SB, L0YB)        |
| LP2985IM5-3.6/NOPB.B                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (L0SB, L0YB)        |
| <a href="#">LP2985IM5-3.8/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0YB                |
| LP2985IM5-3.8/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0YB                |
| LP2985IM5-3.8/NOPB.B                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0YB                |
| <a href="#">LP2985IM5-4.0/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0TB                |
| LP2985IM5-4.0/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0TB                |
| <a href="#">LP2985IM5-4.5/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -            | LA7B                |
| LP2985IM5-4.5/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LA7B                |
| <a href="#">LP2985IM5-5.0/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |
| LP2985IM5-5.0/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |
| LP2985IM5-5.0/NOPB.B                | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |
| <a href="#">LP2985IM5-5.7/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | LKTB                |
| LP2985IM5-5.7/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LKTB                |
| LP2985IM5-5.7/NOPB.B                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LKTB                |
| <a href="#">LP2985IM5-6.1/NOPB</a>  | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | LF6B                |
| LP2985IM5-6.1/NOPB.A                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6B                |
| LP2985IM5-6.1/NOPB.B                | Active        | Production           | SOT-23 (DBV)   5 | 1000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LF6B                |
| LP2985IM5X-2.5/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUB                |
| LP2985IM5X-2.5/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LAUB                |
| <a href="#">LP2985IM5X-2.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LAUB                |
| LP2985IM5X-2.7/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LALB                |
| <a href="#">LP2985IM5X-2.7/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | LALB                |
| LP2985IM5X-2.8/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0KB                |
| <a href="#">LP2985IM5X-2.8/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0KB                |
| LP2985IM5X-3.0/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| LP2985IM5X-3.0/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| <a href="#">LP2985IM5X-3.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0OB                |
| LP2985IM5X-3.3/NO.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| LP2985IM5X-3.3/NO.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |

| Orderable part number               | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LP2985IM5X-3.3/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0RB                |
| <a href="#">LP2985IM5X-3.6/NO.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0SB                |
| <a href="#">LP2985IM5X-3.6/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | L0SB                |
| <a href="#">LP2985IM5X-4.0/NO.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0TB                |
| <a href="#">LP2985IM5X-4.0/NO.B</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0TB                |
| <a href="#">LP2985IM5X-4.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0TB                |
| <a href="#">LP2985IM5X-4.5/NO.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LA7B                |
| <a href="#">LP2985IM5X-4.5/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -            | LA7B                |
| <a href="#">LP2985IM5X-5.0/NO.A</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |
| <a href="#">LP2985IM5X-5.0/NO.B</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |
| <a href="#">LP2985IM5X-5.0/NOPB</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | L0UB                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LP2985AIM5-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-2.7/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-2.8/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-2.9/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-3.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-3.1/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-3.3/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-3.6/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-3.8/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-4.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-4.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-5.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-5.7/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5-6.1/NOPB  | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-2.5/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-2.6/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

| Device               | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LP2985AIM5X-2.8/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-2.9/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.1/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.3/NOPB | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.6/M3   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.6/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-3.8/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-4.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-4.5/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-5.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985AIM5X-6.1/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-2.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-2.7/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-2.8/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-2.9/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.1/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.2/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.3/NOM3   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.3/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.6/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-3.8/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-4.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-4.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-5.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-5.7/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5-6.1/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-2.7/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-2.8/NOPB  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-3.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-3.3/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-3.6/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-4.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-4.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LP2985IM5X-5.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP2985AIM5-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-2.7/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-2.8/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-2.9/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-3.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-3.1/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-3.3/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5-3.6/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5-3.8/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5-4.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5-4.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5-5.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-5.7/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5-6.1/NOPB  | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-2.5/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-2.6/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-2.8/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-2.9/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |

| Device               | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP2985AIM5X-3.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-3.1/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-3.3/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5X-3.6/M3   | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5X-3.6/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-3.8/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-4.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-4.5/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985AIM5X-5.0/NOPB | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985AIM5X-6.1/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-2.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-2.7/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-2.8/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-2.9/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.1/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.2/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.3/NOM3   | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985IM5-3.3/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.6/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-3.8/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-4.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985IM5-4.5/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-5.0/NOPB   | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-5.7/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5-6.1/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-2.7/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-2.8/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LP2985IM5X-3.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-3.3/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-3.6/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-4.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-4.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LP2985IM5X-5.0/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |



## SOT-23 - 1.45 mm max height

## SMALL OUTLINE TRANSISTOR



1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

# EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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